

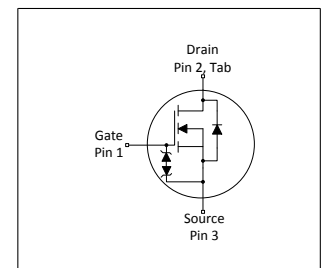
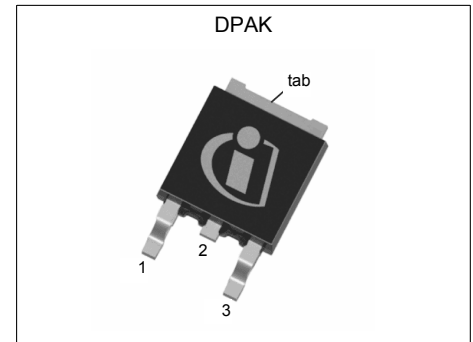
## MOSFET

### 700V CoolMOS™ P7 Power Transistor

CoolMOS™ is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies.

The latest CoolMOS™ P7 is an optimized platform tailored to target cost sensitive applications in consumer markets such as charger, adapter, lighting, TV, etc.

The new series provides all the benefits of a fast switching Superjunction MOSFET, combined with an excellent price/performance ratio and state of the art ease-of-use level. The technology meets highest efficiency standards and supports high power density, enabling customers going towards very slim designs.



### Features

- Extremely low losses due to very low FOM  $R_{DS(on)} * Q_g$  and  $R_{DS(on)} * E_{oss}$
- Excellent thermal behavior
- Integrated ESD protection diode
- Low switching losses ( $E_{oss}$ )
- Product validation acc. JEDEC Standard

### Benefits

- Cost competitive technology
- Lower temperature
- High ESD ruggedness
- Enables efficiency gains at higher switching frequencies
- Enables high power density designs and small form factors

### Potential applications

Recommended for Flyback topologies for example used in Chargers, Adapters, Lighting Applications, etc.

*Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.*

**Table 1 Key Performance Parameters**

| Parameter                    | Value | Unit     |
|------------------------------|-------|----------|
| $V_{DS} @ T_{j=25^{\circ}C}$ | 700   | V        |
| $R_{DS(on),max}$             | 0.6   | $\Omega$ |
| $Q_{g,typ}$                  | 10.5  | nC       |
| $I_{D,pulse}$                | 20.5  | A        |
| $E_{oss} @ 400V$             | 1.2   | $\mu J$  |
| $V_{(GS)th,typ}$             | 3     | V        |
| ESD class (HBM)              | 2     |          |

| Type / Ordering Code | Package     | Marking  | Related Links  |
|----------------------|-------------|----------|----------------|
| IPD70R600P7S         | PG-TO 252-3 | 70S600P7 | see Appendix A |

## Table of Contents

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## 1 Maximum ratings

at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

**Table 2 Maximum ratings**

| Parameter                                                                    | Symbol         | Values     |      |            | Unit             | Note / Test Condition                                                       |
|------------------------------------------------------------------------------|----------------|------------|------|------------|------------------|-----------------------------------------------------------------------------|
|                                                                              |                | Min.       | Typ. | Max.       |                  |                                                                             |
| Continuous drain current <sup>1)</sup>                                       | $I_D$          | -          | -    | 8.5<br>5.0 | A                | $T_C = 20^\circ\text{C}$<br>$T_C = 100^\circ\text{C}$                       |
| Pulsed drain current <sup>2)</sup>                                           | $I_{D,pulse}$  | -          | -    | 20.5       | A                | $T_C=25^\circ\text{C}$                                                      |
| Application (Flyback) relevant avalanche current, single pulse <sup>3)</sup> | $I_{AS}$       | -          | -    | 3.2        | A                | measured with standard leakage inductance of transformer of $7\mu\text{H}$  |
| MOSFET dv/dt ruggedness                                                      | dv/dt          | -          | -    | 100        | V/ns             | $V_{DS} = 0 \dots 400\text{V}$                                              |
| Gate source voltage                                                          | $V_{GS}$       | -16<br>-30 | -    | 16<br>30   | V                | static;<br>AC ( $f > 1\text{ Hz}$ )                                         |
| Power dissipation                                                            | $P_{tot}$      | -          | -    | 43.1       | W                | $T_C=25^\circ\text{C}$                                                      |
| Operating and storage temperature                                            | $T_j, T_{stg}$ | -40        | -    | 150        | $^\circ\text{C}$ | -                                                                           |
| Continuous diode forward current                                             | $I_S$          | -          | -    | 5.9        | A                | $T_C=25^\circ\text{C}$                                                      |
| Diode pulse current <sup>2)</sup>                                            | $I_{S,pulse}$  | -          | -    | 20.5       | A                | $T_C = 25^\circ\text{C}$                                                    |
| Reverse diode dv/dt <sup>4)</sup>                                            | dv/dt          | -          | -    | 1          | V/ns             | $V_{DS} = 0 \dots 400\text{V}$ , $I_{SD} \leq I_S$ , $T_j=25^\circ\text{C}$ |
| Maximum diode commutation speed <sup>4)</sup>                                | di/dt          | -          | -    | 50         | A/ $\mu\text{s}$ | $V_{DS} = 0 \dots 400\text{V}$ , $I_{SD} \leq I_S$ , $T_j=25^\circ\text{C}$ |
| Insulation withstand voltage                                                 | $V_{ISO}$      | -          | -    | n.a.       | V                | $V_{rms}$ , $T_C=25^\circ\text{C}$ , $t=1\text{ min}$                       |

## 2 Thermal characteristics

**Table 3 Thermal characteristics**

| Parameter                                               | Symbol      | Values |      |      | Unit               | Note / Test Condition                                                                                                                                                                                                   |
|---------------------------------------------------------|-------------|--------|------|------|--------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                                         |             | Min.   | Typ. | Max. |                    |                                                                                                                                                                                                                         |
| Thermal resistance, junction                            | $R_{thJC}$  | -      | -    | 2.9  | $^\circ\text{C/W}$ | -                                                                                                                                                                                                                       |
| Thermal resistance, junction - ambient                  | $R_{thJA}$  | -      | -    | 62   | $^\circ\text{C/W}$ | Device on PCB, minimal footprint                                                                                                                                                                                        |
| Thermal resistance, junction - ambient for SMD version  | $R_{thJA}$  | -      | 35   | 45   | $^\circ\text{C/W}$ | Device on $40\text{mm} \times 40\text{mm} \times 1.5$ epoxy PCB FR4 with $6\text{cm}^2$ (one layer $70\mu\text{m}$ thickness) copper area for drain connection and cooling. PCB is vertical without air stream cooling. |
| Soldering temperature, wave- & reflow soldering allowed | $T_{solid}$ | -      | -    | 260  | $^\circ\text{C}$   | reflow MSL3                                                                                                                                                                                                             |

<sup>1)</sup> Limited by  $T_{j,max}$ .  $T_j = 20^\circ\text{C}$ . Maximum duty cycle  $D=0.5$

<sup>2)</sup> Pulse width  $t_p$  limited by  $T_{j,max}$

<sup>3)</sup> Proven during verification test. For explanation please read AN - CoolMOS™ 700V P7.

<sup>4)</sup>  $V_{DClink}=400\text{V}$ ;  $V_{DS,peak} < V_{(BR)DSS}$ ; identical low side and high side switch with identical  $R_G$

### 3 Electrical characteristics

**Table 4 Static characteristics**

| Parameter                                     | Symbol        | Values |      |      | Unit     | Note / Test Condition                                                                 |
|-----------------------------------------------|---------------|--------|------|------|----------|---------------------------------------------------------------------------------------|
|                                               |               | Min.   | Typ. | Max. |          |                                                                                       |
| Drain-source breakdown voltage                | $V_{(BR)DSS}$ | 700    | -    | -    | V        | $V_{GS}=0V, I_D=1mA$                                                                  |
| Gate threshold voltage                        | $V_{(GS)th}$  | 2.50   | 3    | 3.50 | V        | $V_{DS}=V_{GS}, I_D=0.09mA$                                                           |
| Zero gate voltage drain current               | $I_{DSS}$     | -      | -    | 1    | $\mu A$  | $V_{DS}=700V, V_{GS}=0V, T_j=25^\circ C$<br>$V_{DS}=700V, V_{GS}=0V, T_j=150^\circ C$ |
| Gate-source leakage current incl. Zener diode | $I_{GSS}$     | -      | -    | 1    | $\mu A$  | $V_{GS}=20V, V_{DS}=0V$                                                               |
| Drain-source on-state resistance              | $R_{DS(on)}$  | -      | 0.49 | 0.60 | $\Omega$ | $V_{GS}=10V, I_D=1.8A, T_j=25^\circ C$<br>$V_{GS}=10V, I_D=1.8A, T_j=150^\circ C$     |
| Gate resistance                               | $R_G$         | -      | 10   | -    | $\Omega$ | $f=1\text{ MHz, open drain}$                                                          |

**Table 5 Dynamic characteristics**

| Parameter                                                  | Symbol       | Values |      |      | Unit | Note / Test Condition                                   |
|------------------------------------------------------------|--------------|--------|------|------|------|---------------------------------------------------------|
|                                                            |              | Min.   | Typ. | Max. |      |                                                         |
| Input capacitance                                          | $C_{iss}$    | -      | 364  | -    | pF   | $V_{GS}=0V, V_{DS}=400V, f=250kHz$                      |
| Output capacitance                                         | $C_{oss}$    | -      | 7    | -    | pF   | $V_{GS}=0V, V_{DS}=400V, f=250kHz$                      |
| Effective output capacitance, energy related <sup>1)</sup> | $C_{o(er)}$  | -      | 17   | -    | pF   | $V_{GS}=0V, V_{DS}=0...400V$                            |
| Effective output capacitance, time related <sup>2)</sup>   | $C_{o(tr)}$  | -      | 200  | -    | pF   | $I_D=constant, V_{GS}=0V, V_{DS}=0...400V$              |
| Turn-on delay time                                         | $t_{d(on)}$  | -      | 14   | -    | ns   | $V_{DD}=400V, V_{GS}=13V, I_D=1.4A,$<br>$R_G=5.3\Omega$ |
| Rise time                                                  | $t_r$        | -      | 5.5  | -    | ns   | $V_{DD}=400V, V_{GS}=13V, I_D=1.4A,$<br>$R_G=5.3\Omega$ |
| Turn-off delay time                                        | $t_{d(off)}$ | -      | 63   | -    | ns   | $V_{DD}=400V, V_{GS}=13V, I_D=1.4A,$<br>$R_G=5.3\Omega$ |
| Fall time                                                  | $t_f$        | -      | 23   | -    | ns   | $V_{DD}=400V, V_{GS}=13V, I_D=1.4A,$<br>$R_G=5.3\Omega$ |

**Table 6 Gate charge characteristics**

| Parameter             | Symbol        | Values |      |      | Unit | Note / Test Condition                           |
|-----------------------|---------------|--------|------|------|------|-------------------------------------------------|
|                       |               | Min.   | Typ. | Max. |      |                                                 |
| Gate to source charge | $Q_{gs}$      | -      | 1.6  | -    | nC   | $V_{DD}=400V, I_D=1.4A, V_{GS}=0\text{ to }10V$ |
| Gate to drain charge  | $Q_{gd}$      | -      | 3.7  | -    | nC   | $V_{DD}=400V, I_D=1.4A, V_{GS}=0\text{ to }10V$ |
| Gate charge total     | $Q_g$         | -      | 10.5 | -    | nC   | $V_{DD}=400V, I_D=1.4A, V_{GS}=0\text{ to }10V$ |
| Gate plateau voltage  | $V_{plateau}$ | -      | 4.4  | -    | V    | $V_{DD}=400V, I_D=1.4A, V_{GS}=0\text{ to }10V$ |

<sup>1)</sup>  $C_{o(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 400V

<sup>2)</sup>  $C_{o(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 400V

**Table 7 Reverse diode characteristics**

| Parameter                     | Symbol    | Values |      |      | Unit    | Note / Test Condition                   |
|-------------------------------|-----------|--------|------|------|---------|-----------------------------------------|
|                               |           | Min.   | Typ. | Max. |         |                                         |
| Diode forward voltage         | $V_{SD}$  | -      | 0.9  | -    | V       | $V_{GS}=0V, I_F=2.5A, T_j=25^\circ C$   |
| Reverse recovery time         | $t_{rr}$  | -      | 190  | -    | ns      | $V_R=400V, I_F=1.4A, di_F/dt=50A/\mu s$ |
| Reverse recovery charge       | $Q_{rr}$  | -      | 0.8  | -    | $\mu C$ | $V_R=400V, I_F=1.4A, di_F/dt=50A/\mu s$ |
| Peak reverse recovery current | $I_{rrm}$ | -      | 9    | -    | A       | $V_R=400V, I_F=1.4A, di_F/dt=50A/\mu s$ |

## 4 Electrical characteristics diagrams

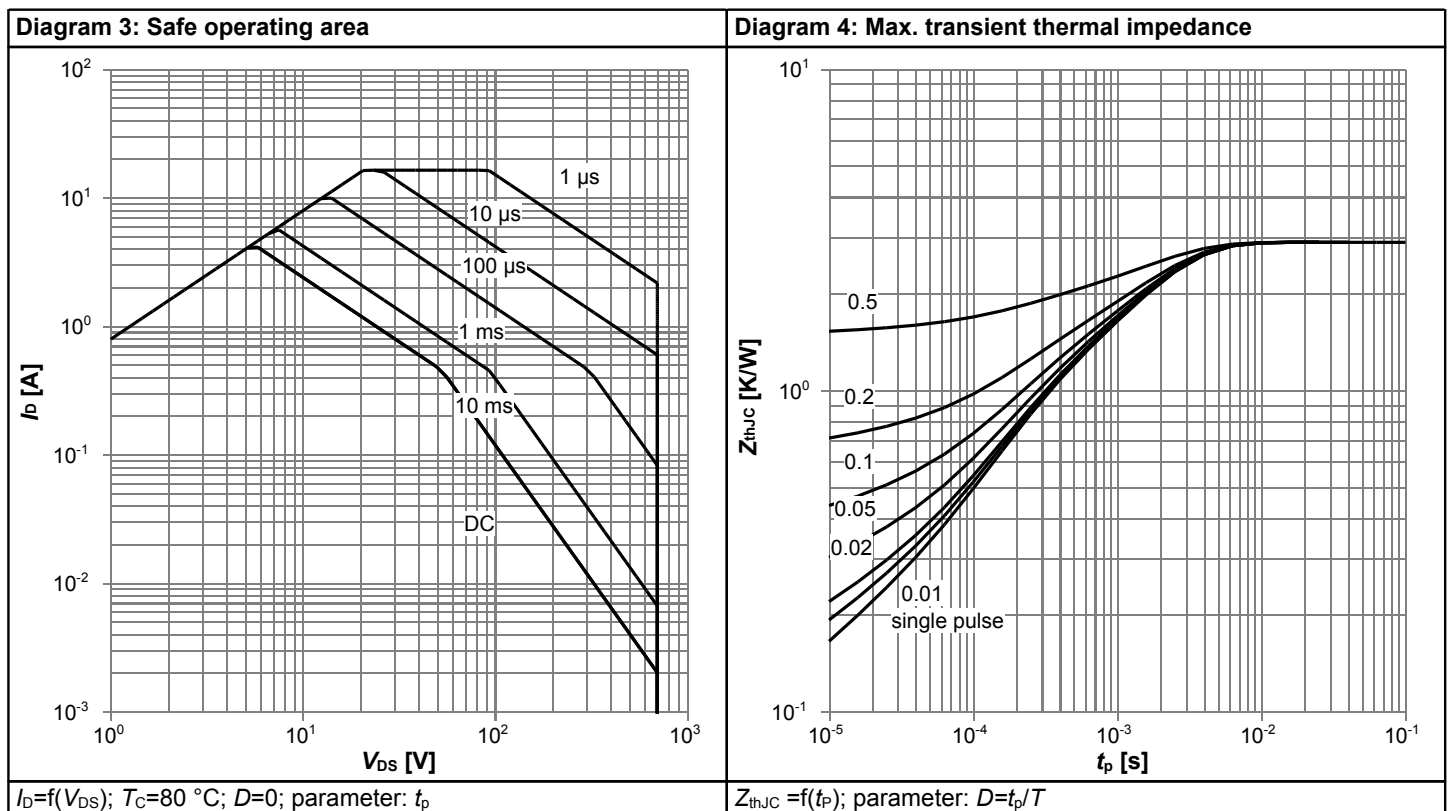
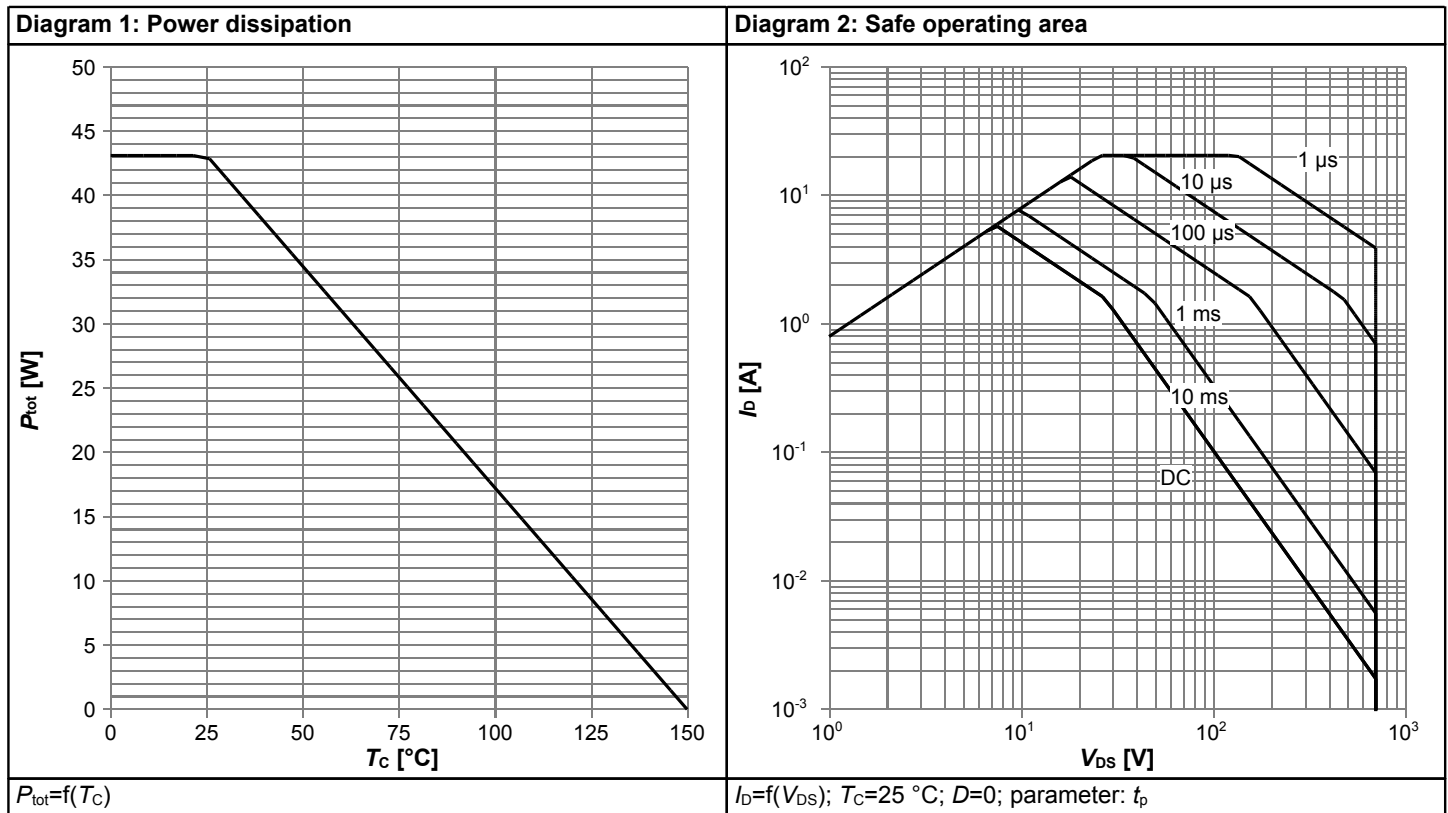
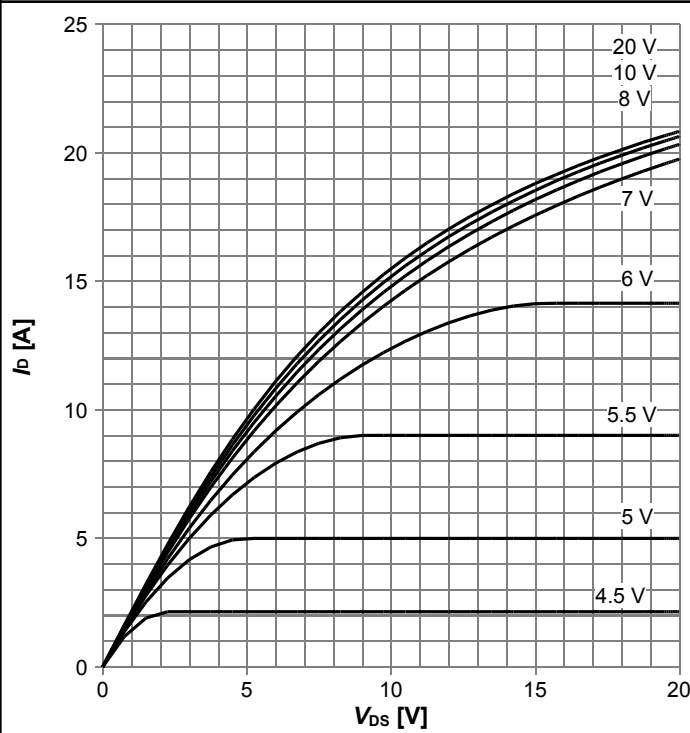
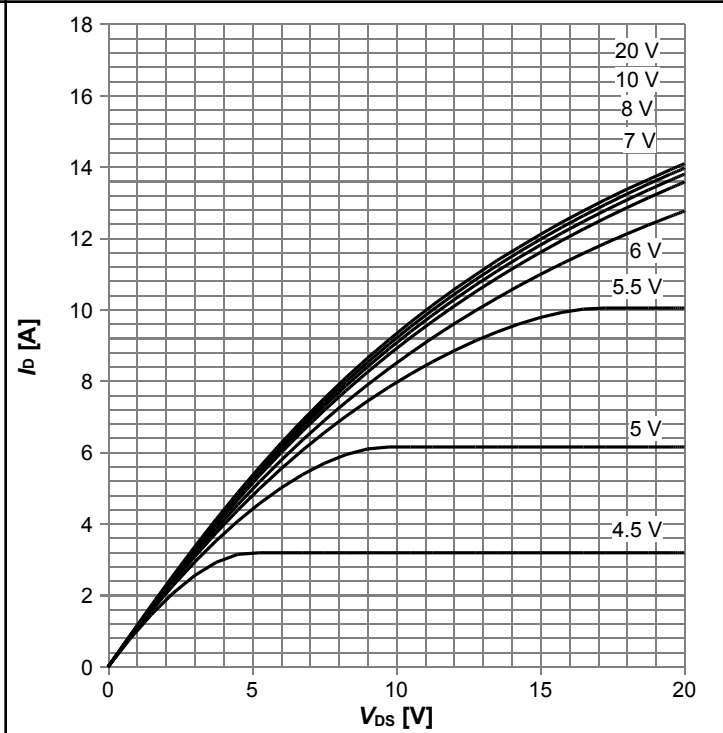


Diagram 5: Typ. output characteristics



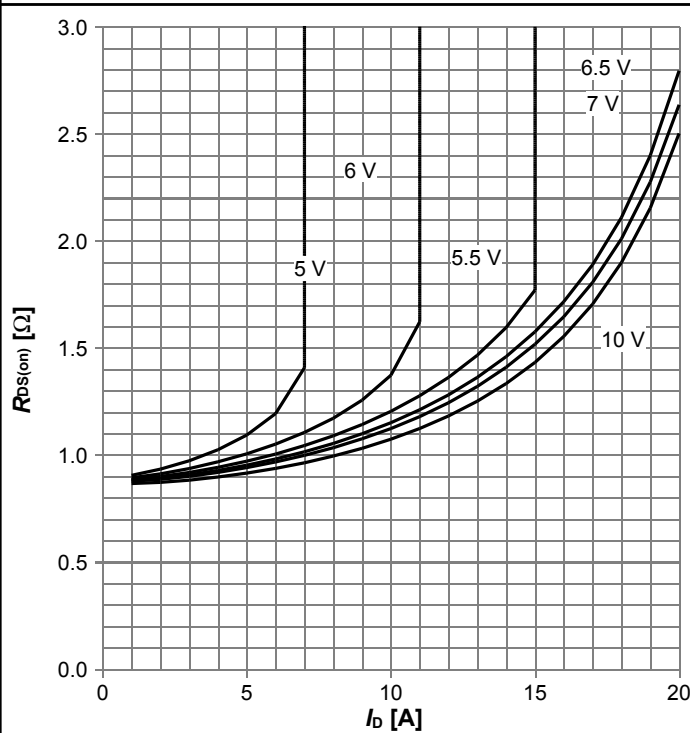
$I_D=f(V_{DS})$ ;  $T_j=25\text{ °C}$ ; parameter:  $V_{GS}$

Diagram 6: Typ. output characteristics



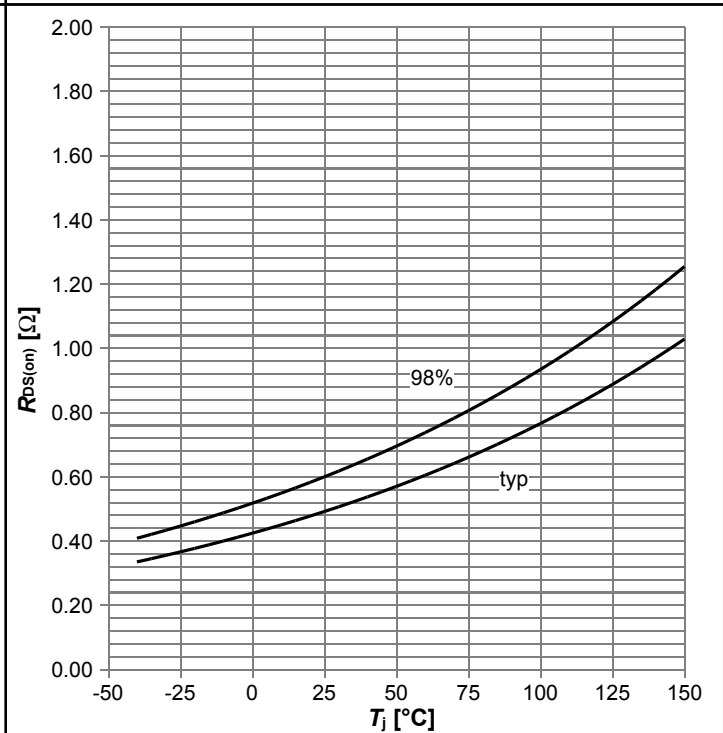
$I_D=f(V_{DS})$ ;  $T_j=125\text{ °C}$ ; parameter:  $V_{GS}$

Diagram 7: Typ. drain-source on-state resistance



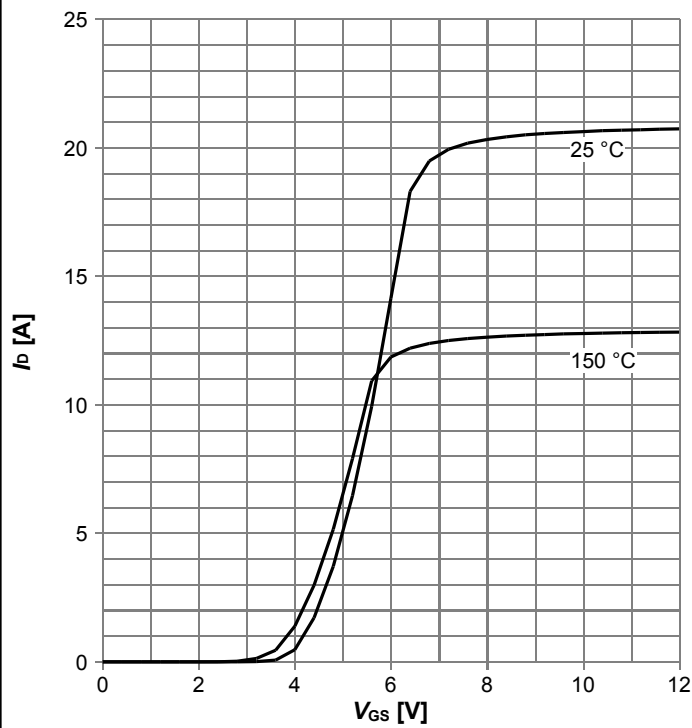
$R_{DS(on)}=f(I_D)$ ;  $T_j=125\text{ °C}$ ; parameter:  $V_{GS}$

Diagram 8: Drain-source on-state resistance



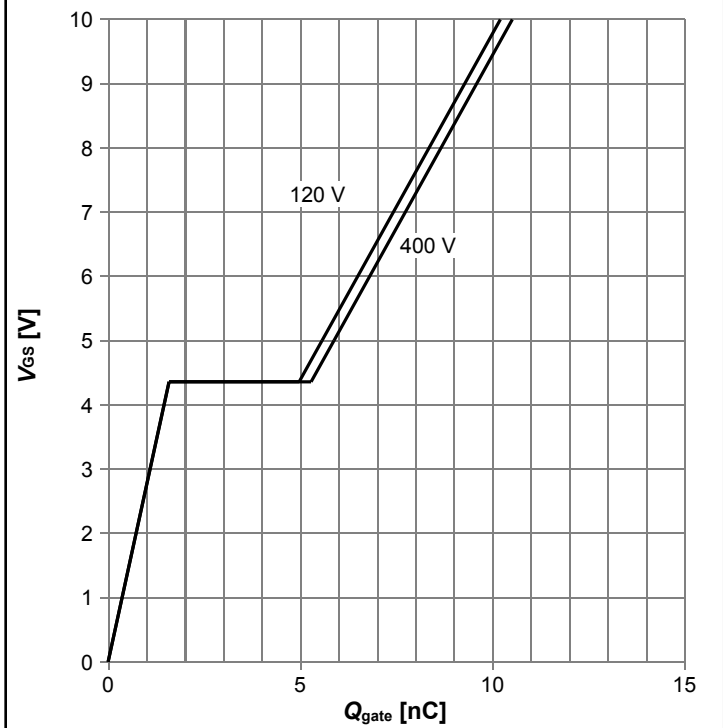
$R_{DS(on)}=f(T_j)$ ;  $I_D=1.8\text{ A}$ ;  $V_{GS}=10\text{ V}$

Diagram 9: Typ. transfer characteristics



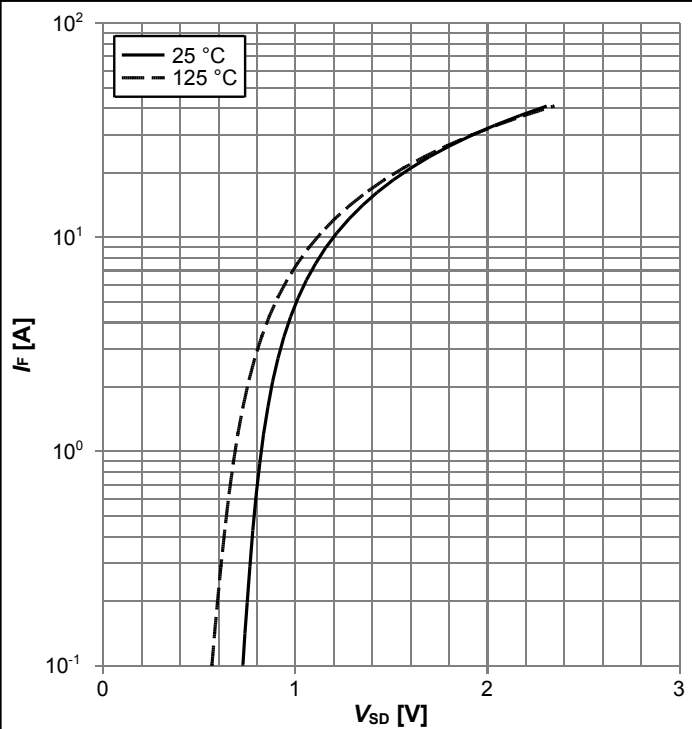
$I_D = f(V_{GS}); V_{DS} = 20V; \text{parameter: } T_j$

Diagram 10: Typ. gate charge



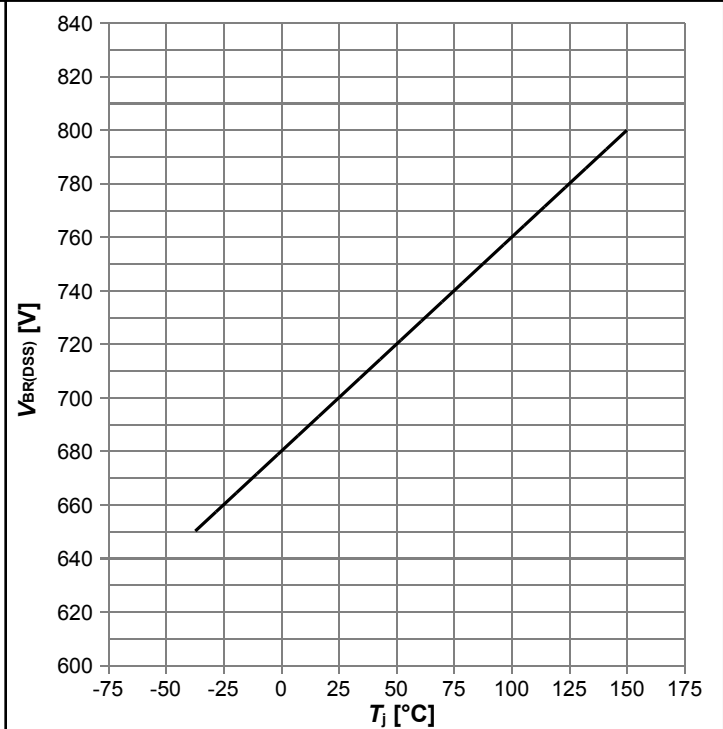
$V_{GS} = f(Q_{gate}); I_D = 1.4 \text{ A pulsed}; \text{parameter: } V_{DD}$

Diagram 11: Forward characteristics of reverse diode



$I_F = f(V_{SD}); \text{parameter: } T_j$

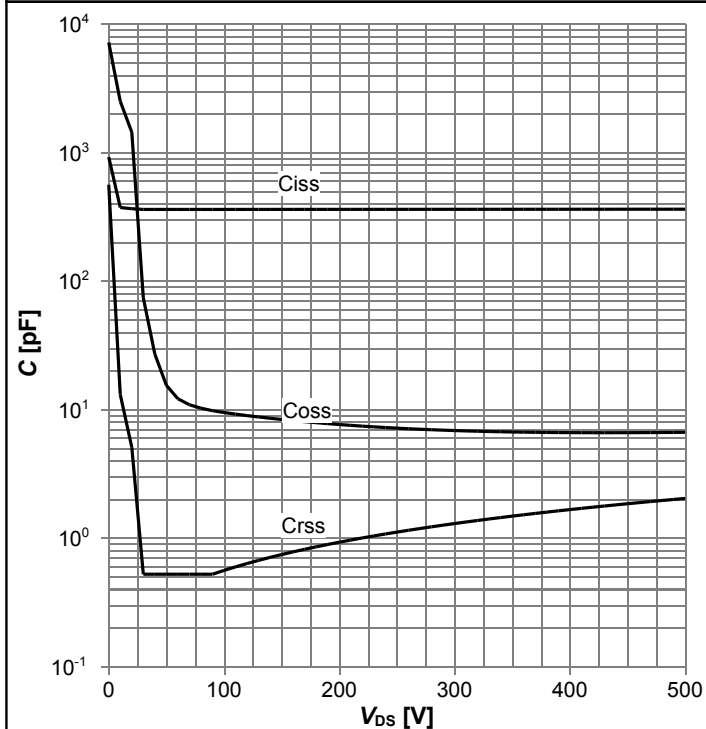
Diagram 13: Drain-source breakdown voltage



$V_{BR(DSS)} = f(T_j); I_D = 1 \text{ mA}$

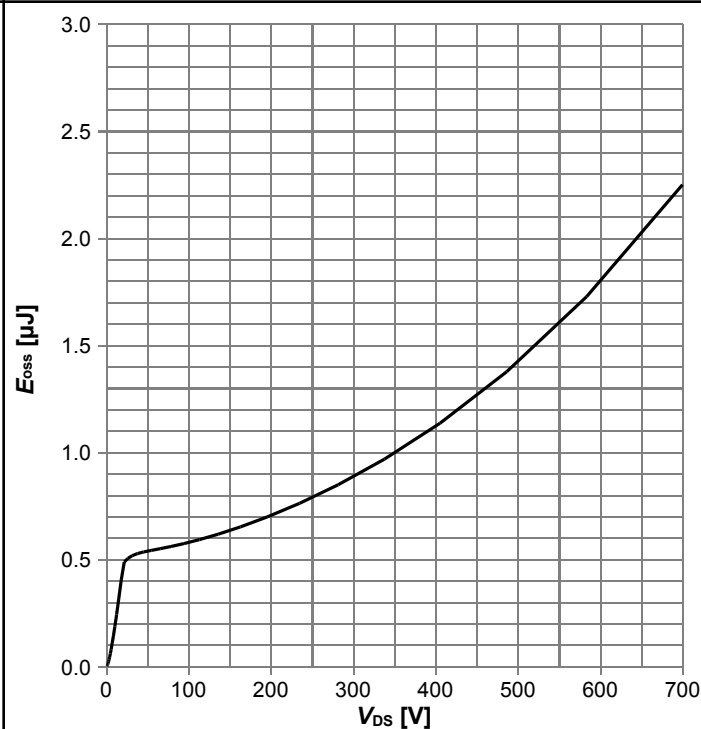


Diagram 14: Typ. capacitances



$C=f(V_{Ds}); V_{GS}=0\text{ V}; f=250\text{ kHz}$

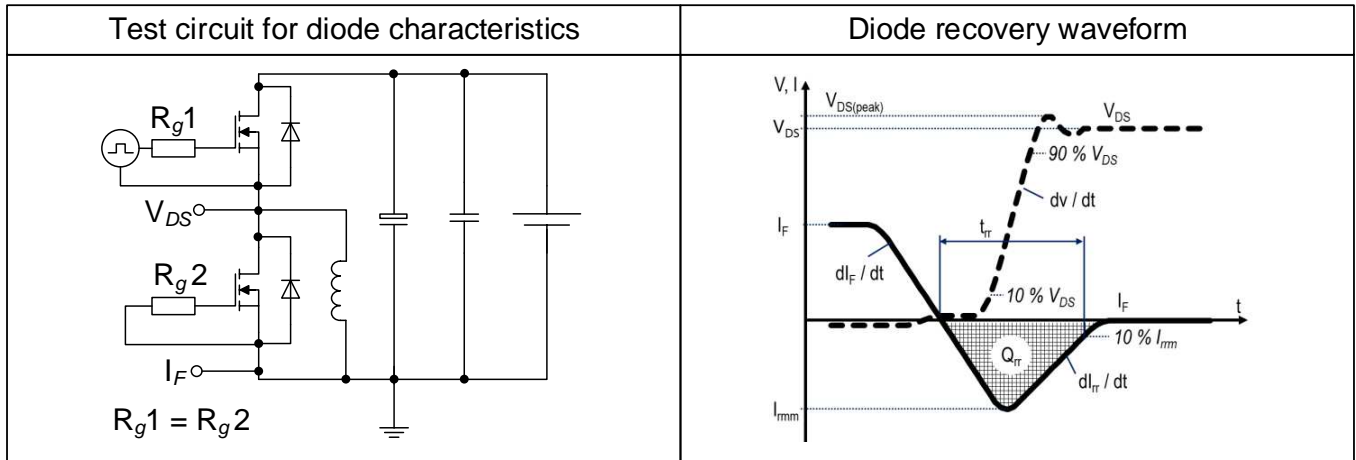
Diagram 15: Typ. Coss stored energy



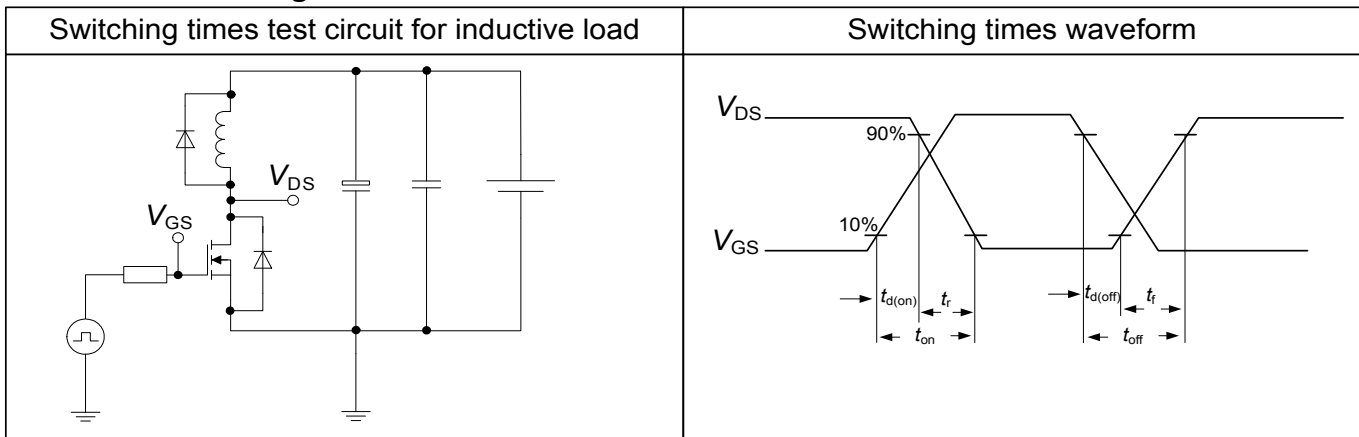
$E_{oss}=f(V_{Ds})$

## 5 Test Circuits

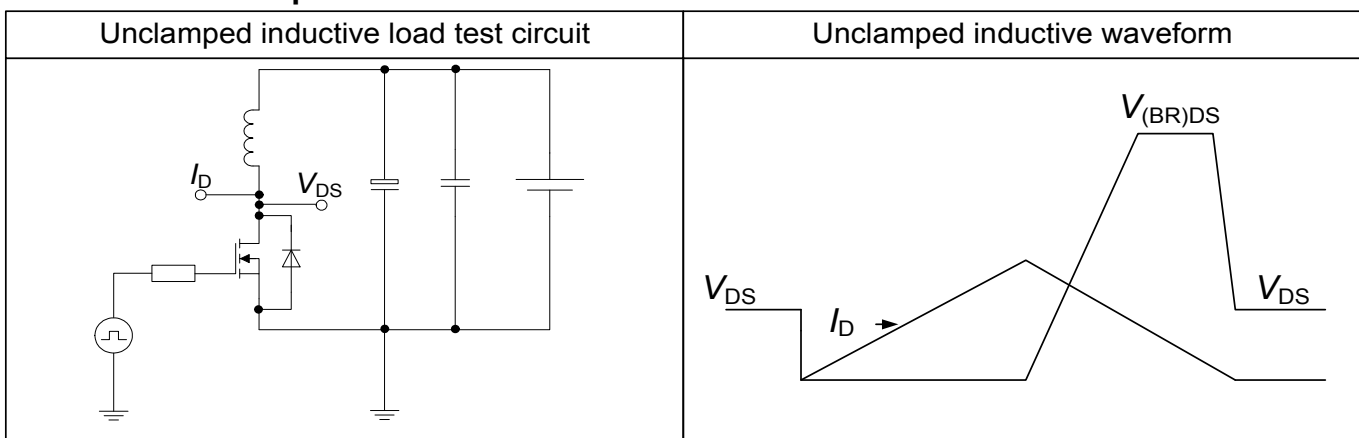
**Table 8 Diode characteristics**



**Table 9 Switching times**



**Table 10 Unclamped inductive load**



## 6 Package Outlines

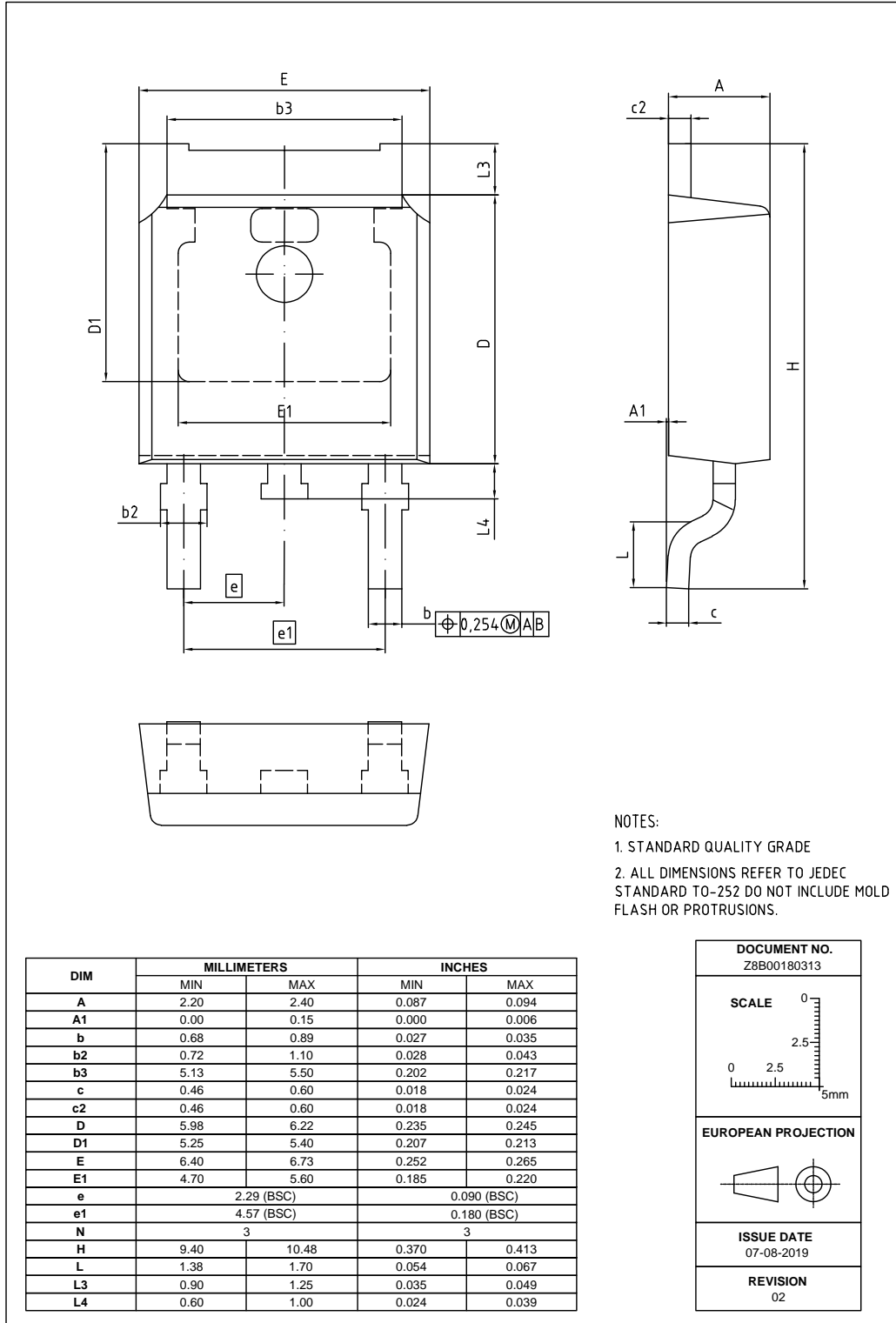


Figure 1 Outline PG-TO 252-3, dimensions in mm/inches

## 7 Appendix A

### Table 11 Related Links

- IFX CoolMOS™ P7 Webpage: [www.infineon.com](http://www.infineon.com)
- IFX Design tools: [www.infineon.com](http://www.infineon.com)

## Revision History

IPD70R600P7S

**Revision: 2019-08-09, Rev. 2.2**

Previous Revision

| Revision | Date       | Subjects (major changes since last revision) |
|----------|------------|----------------------------------------------|
| 2.0      | 2016-10-11 | Release of final version                     |
| 2.1      | 2018-02-12 | Corrected front page text                    |
| 2.2      | 2019-08-09 | Updated package outline                      |

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